PRODUCT: TFT TOUCH MODULE

MODEL NO.: T101GBP005-V0

SUPPLIER: Shenzhen Wanty Phohoelectric Co., Ltd

DATE: Dec,24,2019

SPECIFICATION

Revision: 0.0

T101GBP005-V0

This module uses ROHS material

This specification may change without prior notice in order to improve performance or quality. Please contact Wanty department for updated specification and product status before design for this product or release of this order.

REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
0.0	2019-12-24	First release	Preliminary

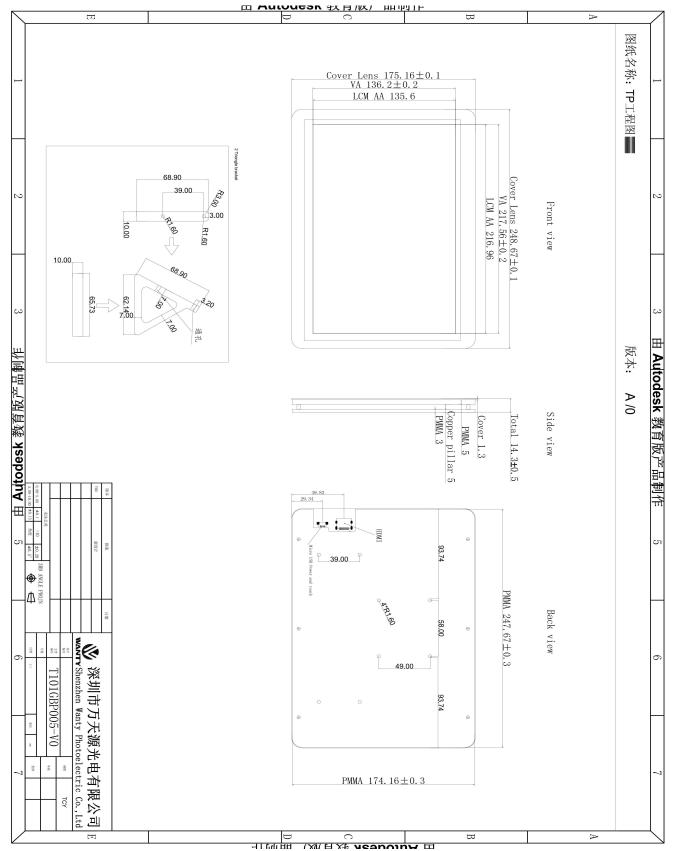
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1. GENERAL INFORMATION

Item of general information		Contents	Unit	
LCD Display Size(Diagonal)		10.1		
Module Structure	LCD Displa	ay + CTP Touch + PCB	-	
LCD Display Type	TFT/	ΓRANSMISSIVE	-	
LCD Display Mode	N	ormally Black	-	
Recommended Viewing Direction		Free	-	
Gray inversion Direction		Free	-	
Module size (W×H×T)	248.	67×175.16×14.3	mm	
Active area (W×H)	2	mm		
Number of pixels(Resolution)	12	280RGB×800	pixel	
Pixel pitch (W×H)	0	.1695×0.1695	mm	
Color Pixel Arrangement		RGB Stripe	-	
Madula Intenface Temp	LCD Display	HDMI interface	-	
Module Interface Type	CTP I2C	USB interface	-	
	Win7/Win8	-		
System Support	Android/Linux	-		
Power Supply	USB(5.0V)		-	
Module Power consumption	800(Typ.)		mA	
Color Numbers	16.7M		-	
Backlight Type	White LED		-	

2, EXTERNAL DIMENSIONS



3, ABSOLUTE MAXIMUM RATINGS

Parameter of absolute maximum ratings	Symbol	Min	Max	Unit
Operating temperature	Тор	-10	60	${\mathbb C}$
Storage temperature	Tst	-20	70	$^{\circ}$
Humidity	RH	-	90%(Max 60°C)	RH

Note: Absolute maximum ratings means the product can withstand short-term, not more than 120 hours. If the product is a long time to withstand these conditions, the life time would be shorter.

4、ELECTRICAL CHARACTERISTICS(DC CHARACTERISTICS)

Parameter of DC	Symbol	Min.	Тур.	Max.	Unit
characteristics	Symbol	1 V1111.	ıyp.	wiax.	Onit
PCB operating voltage	VCC5V	-	5.0	-	V
LCD I/O operating voltage	VDD	2.3	2.5	2.7	V
Input voltage 'H' level	VIH	0.8*VDD	-	VDD	V
Input voltage 'L' level	VIL	VSS	-	0.2*VDD	V
Output voltage 'H' level	VOH	VDD-0.4	-	VDD	V
Output voltage 'L' level	VOL	VSS	-	VSS+0.4	V

5. CTP CHARACTERISTICS

Item of CTP	Specification	Unit	Remark
Panel Type	Glass Cover + Glass Sensor	-	-
Resolution	1280 ×800	pixel	-
Surface Hardness	6Н	-	-
Transparency	≥86%	-	-
Driver IC	-	-	-
Interface Type	USB interface	-	-
Support Points	10	-	-
Sampling Rate	20~100	Hz	-
Supply voltage	3.3	V	-

6, ELECTRO-OPTICAL CHARACTERISTICS

Item (electro-o _l character	otical	Symbol	Condition	Min.	Тур.	Max.	Unit	Remark	Note
Response	time	Tr+Tf	0-0	-	25	50	ms	FIG 1.	4
Contrast F	Ratio	CR	θ=0 Ø=0	-	600	-	-	FIG 2.	1
Luminance un	iformity	δWHITE	Ta=25°C	-	80	-	%	FIG 2.	3
Surface Lum	ninance	Lv		-	300	-	cd/m2	FIG 2.	2
CIE (x, y)		White x	θ=0	0.27	0.31	0.35			
chromaticity	White	White y	Ø=0 Ta=25 °C	0.28	0.32	0.36	-	FIG 2.	5
	Ø=90(1	2 o'clock)		75	85	-	deg		
Viewing	Ø=270(6 o'clock)	o'clock)		85	-	deg	FIG 3.	6
angle range	Ø=0(3 d	o'clock)	CR ≥ 10	75	85	-	deg	F10 5.	U
	Ø=180(9 o'clock)		75	85	-	deg		
NTSC ratio		-	-	-	50	-	%	-	-

Note 1. Contrast Ratio(CR) is defined mathematically by the following formula. For more information see FIG 2.:

 $Contrast\ Ratio(CR) = \frac{Average\ Surface\ Luminance\ with\ all\ white\ pixels(P1,P2,P3,P4,P5,P6,P7,P8,P9)}{Average\ Surface\ Luminance\ with\ all\ black\ pixels(P1,P2,P3,P4,P5,P6,P7,P8,P9)}$

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv=Average Surface Luminance with all white pixels (P1,P2,P 3,P4, P5,P6,P7,P8,P9)

Note 3. The uniformity in surface luminance (δWHITE) is determined by measuring luminance at each test position 1 through 9, and then dividing the maximum luminance of

9points luminance by minimum luminance of 9 points luminance. For more information see

FIG 2.

 $\delta \text{WHITE} = \frac{\text{Minimum Surface Luminance with all white pixels (P1, P2, P3, P4, P5, P6, P7, P8, P9)}}{\text{Maximum Surface Luminance with all white pixels (P1, P2, P3, P4, P5, P6, P7, P8, P9)}}$

Note 4. The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%. For more information see FIG 1.

Note 5. CIE (x, y) chromaticity ,The x,y value is determined by screen active area position 5. For more information see FIG 2.

Note 6. Viewing angle is the angle at which the contrast ratio is greater than a specific value. For TFT module, the specific value of contrast ratio is 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note 7. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on BM-7 photo detector.

Note 8. For TN type TFT transmissive module, Gray scale reverse occurs in the direction of panel viewing angle.

FIG.1. The definition of Response Time

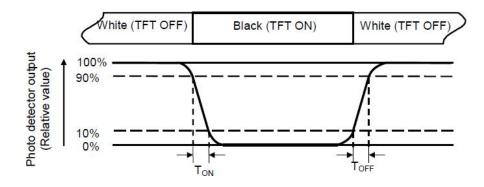


FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance

uniformity, CIE (x, y) chromaticity

A: H/6; B: V/6;

H,V: Active Area(AA) size

Measurement instrument: BM-7; Light spot size=5mm, 350mm distance from the LCD surface to detector lens.

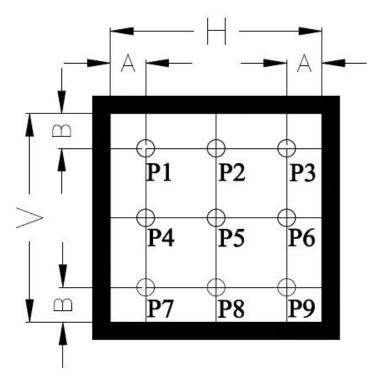
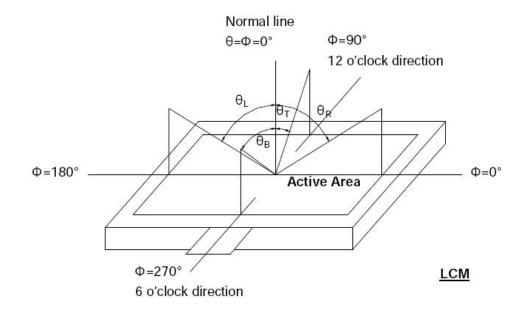


FIG.3. The definition of viewing angle



7. INTERFACE DESCRIPTION

A. HDMI (Type A)Interface Description

	1	
NO.	Symbol	DESCRIPTION
1	TMDS Data2+	Positive side of channel 2 TMDS low-voltage signal differential input pair
2	TMDS Data2 Shield	Ground
3	TMDS Data2-	Negative side of channel 2 TMDS low-voltage signal differential input pair
4	TMDS Data1+	Positive side of channel 1 TMDS low-voltage signal differential input pair
5	TMDS Data1 Shield	Ground
6	TMDS Data1-	Negative side of channel 1 TMDS low-voltage signal differential input pair
7	TMDS Data0+	Positive side of channel 0 TMDS low-voltage signal differential input pair
8	TMDS Data0 Shield	Ground
9	TMDS Data0-	Negative side of channel 0 TMDS low-voltage signal differential input pair
10	TMDS Clock+	Positive side of reference clock. TMDS low-voltage signal differential input pair
11	TMDS Clock Shield	Ground
12	TMDS Clock-	Negative side of reference clock. TMDS low-voltage signal differential input pair
13	CEC	No Connection
14	Reserved(N.C.)	No Connection
15	SCL	DDC SCL
16	SDA	DDC SDA
17	DDC/CEC Ground	Ground
18	+5V Power	+5V Power
19	Hot Plug Detect	Hot Plug Detect

B. Micro USB TOUCH Interface Description

NO.	Symbol	DESCRIPTION
1	VUSB	USB Power
2	D-	USB Data-
3	D+	USB Data+
4	NC	No connection
5	GND	Power Ground

Application Note: Please connect the USB first, and then connect the HDMI 8. LCD TIMING

LCD Timing Table

Parameter	Symbol		Unit		
r ar ameter	Symbol	Min.	Тур.	Max.	
DCLK frequency@ Frame rate=60Hz	DCLK	68.9	71.1	73.4	MHz
Horizontal display area	thd	1280			DCLK
1 Horizontal Line	th	1340	1440	1470	DCLK
HSYNC pulse width	thpw	-	10	-	DCLK
HSYNC Back Porch(Blanking)	thb	-	80	-	DCLK
HSYNC Front Porch	thfp	-	70	-	DCLK
Vertical display area	tvd	800			Н
VSYNC period time	tv	815	823	833	Н
VSYNC pulse width	tvpw	-	3	-	Н
VSYNC Back Porch(Blanking)	tvb	-	10	-	Н
VSYNC Front Porch	tvfp	-	10	-	Н

9、RELIABILITY TEST CONDITIONS

No.	Test Item	Test Condition
1	High Temperature Storage	70°C/120 hours
2	Low Temperature Storage	-20°C/120 hours
3	High Temperature Operating	60°C/120 hours
4	Low Temperature Operating	-10°C/120 hours
5	Temperature Cycle Storage	-10°C(30min.)~25(5min.)~60°C(30min.)×10cycles

A. Inspection after test:

Inspection after 2~4 hours storage at room temperature, the sample shall be free from defects:

- Air bubble in theLCD;
- > Sealleak;
- Non-display;
- Missingsegments;
- ➤ Glasscrack;
- > Current is twice higher than initial value.

B, Remark:

- The test samples should be applied to only one testitem.
- > Sample size for each test item is5~10pcs.
- ➤ Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

10 INSPECTION CRITERION

This specification is made to be used as the standard of acceptance/rejection criteria for TFT-LCD/IPS TFT-LCD module product, and this specification is applicable only in the case that the size of module equal to or exceed than 4.3 inch.

10.1 Sampleplan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993,normal level 2 and based on:

Major defect: AQL 0.65

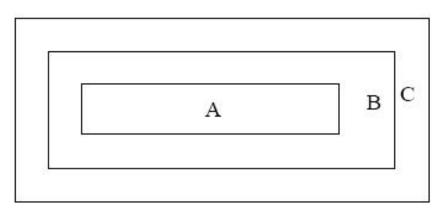
Minor defect: AQL 1.5

10.2 Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of $20\sim40W$ light intensity, all directions for inspecting the sample should be within 45° against perpendicular line. (Normal temperature $20\sim25^{\circ}$ C and normal humidity 60 $\pm15\%$ RH)

10.3 Definition of InspectionItem.

A . Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (Zone A + Zone B=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

B Definition of some visual defect

	Because of losing all or part function, bad pixel dots appear bright and the
Bright dot	size is more than 50% of one dot in which LCD panel is displaying under
	black pattern.
Dowle dat	Dots appear dark and unchanged in size in which LCD panel is displaying
Dark dot	under pure red, green, blue picture, or pure whiter picture.

10.4 MajorDefect

Item No.	Items to be inspected	Inspection standard	Classification of defects
1	Functional defects	1) Nodisplay 2) Display abnormally 3) Missing vertical, horizontalsegment 4) Shortcircuit 5) Excess powerconsumption 6)Backlight no lighting, flickering and abnormal lighting	major
2	Missing	Missing component	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	

10.5. Minor Defect

Item	Items to be	Inspection standard						Classification
No.	inspected							of defects
		Zone Bright pixel do	ot	"~7" 1	Accepta A+B 7~10.1" 2		С	Minor
1	Bright dot /dark dot defect	Dark pixel dot 2bright dots adjace 2dark dots adjace Total bright and dots Note: Minimum dist Pixel dots' function material and other re-	dark ance between is normal, be	ut brig	ht dots ca	used by foreig		
2		Zone $ \begin{array}{c} \text{Size(mm)} \\ \Phi \leqslant 0.2 \\ \hline 0.2 < \Phi \leqslant 0.5 \\ \hline \Phi > 0.5 \end{array} $ Note: 1. Minimum distance 2. The quantity of definition of the second se		7-ce Acc		>10.1" Acceptable 6 0 more than 5 m	O Acceptable :	Minor
3	Linear defect	Zone $Size (mm)$ $Length Width$ $Ignore W \leq 0.05$ $L \leq 5.0 0.05 < \\ W \leq 0.1$ $L > 5.0 W > 0.1$	4.3"~7" Acceptable 4	70	cceptable A+B ~10.1" ceptable 5 0	Qty >10.1" Acceptable 6 0	O Acceptable	Minor

	T							T	
		5.4.1 Pola	rizer Posit	ion					
		(i) Shiftii	ng in positi	on should not	exceed the gla	ass outline			
		dimension	1.						
		(ii) Inco	mplete cov	ering of the vi	ewing area du	e to shifting i	s not		
		allowed.	•	C	C				
			5.4.2 Dirt on polarizer						
		Dirt which							
		5.4.3 Polarizer Dent & Air bubble Zone Acceptable Qty							
		Size(mm)		A+B					
				4.3"~7" 7~10.1" >10.1"			С		
		·	<u>√</u> ≤0.2						
		Ψ,	≥0.2	Acceptable	Acceptable	Acceptable	Ac		
		0.2<	Φ≤0.5	4	5	6	Acceptable		
	Polarizer			_			tabl		
4	defect	Φ	>0.5	0	0	0	ত Min	Minor	
		5.4.4 Pol	arizer scra	atch					
		(i) If the	(i) If the polarizer scratch can be seen after cover assembling						
		or in the	operating	condition, ju	dge by the li	near defect o	of 5.3.		
		(ii)If the							
		condition							
				Acceptable Qty					
		Size (mm)		A+B					
							С		
		Length	Width	4.3"~7"	7~10.1"	>10.1"			
		Ignore	W≤0.05	Acceptable	Acceptable	Acceptable	.		
		<u> </u>		1111			Accept		
			1.0 <l< td=""><td>0.05 < W≤0.20</td><td>4</td><td></td><td>ے</td><td>epta</td><td></td></l<>	0.05 < W≤0.20	4		ے	epta	
		≤5.0		4	5	6	table		
		L>5.0	W>0.2	0	0	0			
	MURA	Using							
5	1,10141	051118							
								Minor	
								Minor	
	White/Black	Visible under: ND3%; D≤0.15mm, Acceptable;							
	dot (MURA)	0.15 mm $<$ D \leq 0.5mm, N \leq 4; D $>$ 0.5mm, Not allowable.							
								· · · · · · · · · · · · · · · · · · ·	

		(i) Crack				
		Cracks are	Minor			
6	Glass defect		Y ≤3.0 orner of termin	Z Not more than the thickness of glass hall not be allowed to perimeter seal.	Acceptable N≤3 o extend	Minor
		(iii) Usual sur	face crack Y ≤1.5	Z Not more than the thickness of glass ble to the upper glass of	Acceptable N≤4 LCD.	Minor

10.6 Module CosmeticCriteria

Item No.	Items to be inspected	Inspection Standard	Classification of defects		
1	Difference in Spec.	Not allowable	Major		
2	Pattern peeling	No substrate pattern peeling and floating	Major		
3		No soldering missing	Major		
	Soldering defects	No soldering bridge	Major		
		No cold soldering	Minor		
4	Resist flaw on PCB	Visible copper foil (Φ0.5 mm or more) on substrate	Minan		
4	Resist flaw on PCB	pattern is not allowed	Minor		
5	FPC gold finger	No dirt, breaking, oxidation lead to black	Major		
6	Backlight plastic frame	No deformation, crack, breaking, backlight positioning column breaking, obvious nick.	Minor		
7	Marking printing effect	No dark marking, incomplete, deformation lead to unable to judge	Minor		
8	Accretion of metallic Foreign matter	No accretion of metallic foreign matter (Not exceed Φ0.2mm)	Minor		
9	Stain	No stain to spoil cosmetic badly	Minor		
10	Plate discoloring	No plate fading, rusting and discoloring	Minor		
	1. Lead parts	a. Soldering side of PCB Solder to form a 'Filet' all around the lead. Solder should not hide the lead form perfectly.	Minor		
		b. Components side(In case of 'Through Hole PCB') Solder to reach the Components side of PCB.	Minor		
11	2. Flat packages	Either 'Toe'(A) or 'Seal'(B)of the lead to be covered by "Filet". Lead form to be assume over Solder.	Minor		
	3. Chips	(3/2) H ≥h ≥(1/2) H \$\int_h \int_H\$	Minor		
	4. Solder ball/Solder splash	a. The spacing between solder ball and the conductor or solder pad h \geq 0.13 mm. The diameter of solder ball d \leq 0.15 mm.	Minor		
		b. The quantity of solder balls or solder splashes isn't beyond 5 in 600 mm2.	Minor		
		c. Solder balls/Solder splashes do not violate minimum electrical clearance.	Major		

11. PRODUCT PHOTOS



